－Operating Range $2-\mathrm{V}$ to $5.5-\mathrm{V} \mathrm{V}_{\mathrm{CC}}$
－3－State Outputs Drive Bus Lines Directly
－Latch－Up Performance Exceeds 250 mA Per JESD 17

SN54AHC374 ．．．J OR W PACKAGE
SN74AHC374 ．．．DB，DGV，DW，N，NS，OR PW PACKAGE （TOP VIEW）

| $\overline{O E} \ 1$ | $\cup_{20}$ | 7 VCC |
| :---: | :---: | :---: |
| 1Q［2 | 19 | 8Q |
| 1 D 3 | 18 | 8D |
| 2D 4 | 17 | 7D |
| 2Q［5 | 16 | 7Q |
| 3Q 6 | 15 | 6Q |
| 3 C 7 | 14 | 6D |
| 4 D 8 | 13 | 5D |
| 4Q ${ }^{9}$ | 12 | 5Q |
| GND［10 | 11 | CLK |

－ESD Protection Exceeds JESD 22
－2000－V Human－Body Model（A114－A）
－200－V Machine Model（A115－A）
－1000－V Charged－Device Model（C101）
SN54AHC374．．．FK PACKAGE
（TOP VIEW）


## description／ordering information

The＇AHC374 devices are octal edge－triggered D－type flip－flops that feature 3－state outputs designed specifically for driving highly capacitive or relatively low－impedance loads．These devices are particularly suitable for implementing buffer registers，I／O ports，bidirectional bus drivers，and working registers．
On the positive transition of the clock（CLK）input，the Q outputs are set to the logic levels of the data（D）inputs． A buffered output－enable（ $\overline{\mathrm{OE}}$ ）input can be used to place the eight outputs in either a normal logic state（high or low）or the high－impedance state．In the high－impedance state，the outputs neither load nor drive the bus lines significantly．The high－impedance state and the increased drive provide the capability to drive bus lines without interface or pullup components．

ORDERING INFORMATION

| $\mathrm{T}_{\text {A }}$ | PACKAGE $\dagger$ |  | ORDERABLE PART NUMBER | TOP－SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | PDIP－N | Tube | SN74AHC374N | SN74AHC374N |
|  | SOIC－DW | Tube | SN74AHC374DW | AHC374 |
|  |  | Tape and reel | SN74AHC374DWR |  |
|  | SOP－NS | Tape and reel | SN74AHC374NSR | AHC374 |
|  | SSOP－DB | Tape and reel | SN74AHC374DBR | HA374 |
|  | TSSOP－PW | Tube | SN74AHC374PW | HA374 |
|  |  | Tape and reel | SN74AHC374PWR |  |
|  | TVSOP－DGV | Tape and reel | SN74AHC374DGVR | HA374 |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | CDIP－J | Tube | SNJ54AHC374J | SNJ54AHC374J |
|  | CFP－W | Tube | SNJ54AHC374W | SNJ54AHC374W |
|  | LCCC－FK | Tube | SNJ54AHC374FK | SNJ54AHC374FK |

$\dagger$ Package drawings，standard packing quantities，thermal data，symbolization，and PCB design guidelines are available at www．ti．com／sc／package．

[^0]
## SN54AHC374, SN74AHC374

OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS
WITH 3-STATE OUTPUTS
SCLS240I - OCTOBER 1995 - REVISED JULY 2003

## description/ordering information (continued)

$\overline{\mathrm{OE}}$ does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.
To ensure the high-impedance state during power up or power down, $\overline{\mathrm{OE}}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| FUNCTION TABLE (each flip-flop) |  |  |  |
| :---: | :---: | :---: | :---: |
| INPUTS |  |  | OUTPUT |
| $\overline{\mathrm{OE}}$ | CLK | D | Q |
| L | $\uparrow$ | H | H |
| L | $\uparrow$ | L | L |
| L | H or L | X | $\mathrm{Q}_{0}$ |
| H | X | X | Z |

logic diagram (positive logic)


To Seven Other Channels

## SN54AHC374, SN74AHC374 OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS <br> WITH 3-STATE OUTPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$
Supply voltage range, $\mathrm{V}_{\mathrm{CC}}$
-0.5 V to 7 V
Input voltage range, $\mathrm{V}_{\mathrm{I}}$ (see Note 1) .................................................................. -0.5 V to 7 V

> Input clamp current, $\mathrm{I}_{\mathrm{IK}}\left(\mathrm{V}_{\mathrm{I}}<0\right)$ -20 mA

> Package thermal impedance, $\theta_{\mathrm{JA}}$ (see Note 2): DB package ..................................... $70^{\circ} \mathrm{C} / \mathrm{W}$
> DGV package ........................................ 92²0 $\mathrm{C} / \mathrm{W}$
> DW package ........................................ $58^{\circ} \mathrm{C} / \mathrm{W}$
> N package . ............................................ $69^{\circ} \mathrm{C} / \mathrm{W}$
> NS package ....................................... $60^{\circ} \mathrm{C} / \mathrm{W}$
> PW package ........................................ $83^{\circ} \mathrm{C} / \mathrm{W}$
> Storage temperature range, $\mathrm{T}_{\text {stg }}$
> $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
> $\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
> NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
> 2. The package thermal impedance is calculated in accordance with JESD 51-7.
recommended operating conditions (see Note 3)


NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | Vcc | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54AHC374 |  | SN74AHC374 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{l} \mathrm{OH}=-50 \mu \mathrm{~A}$ |  |  | 2 V | 1.9 | 2 |  | 1.9 |  | 1.9 |  | V |
|  |  |  | 3 V | 2.9 | 3 |  | 2.9 |  | 2.9 |  |  |  |
|  |  |  | 4.5 V | 4.4 | 4.5 |  | 4.4 |  | 4.4 |  |  |  |
|  | $\mathrm{IOH}=-4 \mathrm{~mA}$ |  | 3 V | 2.58 |  |  | 2.48 |  | 2.48 |  |  |  |
|  | $\mathrm{OH}=-8 \mathrm{~mA}$ |  | 4.5 V | 3.94 |  |  | 3.8 |  | 3.8 |  |  |  |
| VOL | $\mathrm{l} \mathrm{OL}=50 \mu \mathrm{~A}$ |  | 2 V |  |  | 0.1 |  | 0.1 |  | 0.1 | V |  |
|  |  |  | 3 V |  |  | 0.1 |  | 0.1 |  | 0.1 |  |  |
|  |  |  | 4.5 V |  |  | 0.1 |  | 0.1 |  | 0.1 |  |  |
|  | $\mathrm{IOL}=4 \mathrm{~mA}$ |  | 3 V |  |  | 0.36 |  | 0.5 |  | 0.44 |  |  |
|  | $\mathrm{IOL}=8 \mathrm{~mA}$ |  | 4.5 V |  |  | 0.36 |  | 0.5 |  | 0.44 |  |  |
| 1 | $\mathrm{V}_{\mathrm{I}}=5.5 \mathrm{~V}$ or GND |  | 0 V to 5.5 V |  |  | $\pm 0.1$ |  | $\pm 1^{*}$ |  | $\pm 1$ | $\mu \mathrm{A}$ |  |
| IOZ | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND |  | 5.5 V |  |  | $\pm 0.25$ |  | $\pm 2.5$ |  | $\pm 2.5$ | $\mu \mathrm{A}$ |  |
| ICC | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CC }}$ or GND, | $\mathrm{I}=0$ | 5.5 V |  |  | 4 |  | 40 |  | 40 | $\mu \mathrm{A}$ |  |
| $\mathrm{C}_{\mathrm{i}}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CC }}$ or GND |  | 5 V |  | 4 | 10 |  |  |  | 10 | pF |  |
| $\mathrm{C}_{0}$ | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND |  | 5 V |  | 6 |  |  |  |  |  | pF |  |

* On products compliant to MIL-PRF-38535, this parameter is not production tested at $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$.
timing requirements over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted) (see Figure 1)

|  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | SN54AHC374 |  | SN74AHC374 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $t_{\text {w }}$ | Pulse duration, CLK high or low | 5 |  | 5.5 |  | 5.5 |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, data before CLK $\uparrow$ | 4.5 |  | 4 |  | 4 |  | ns |
| $\mathrm{th}_{\mathrm{h}}$ | Hold time, data after CLK $\uparrow$ | 2 |  | 2 |  | 2 |  | ns |

timing requirements over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 0.5 \mathrm{~V}$ (unless otherwise noted) (see Figure 1)

|  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | SN54AHC374 |  | SN74AHC374 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{t}_{\mathrm{w}}$ | Pulse duration, CLK high or low | 5 |  | 5 |  | 5 |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, data before CLK $\uparrow$ | 3 |  | 3 |  | 3 |  | ns |
| $\mathrm{th}^{\text {h }}$ | Hold time, data after CLK $\uparrow$ | 2 |  | 2 |  | 2 |  | ns |

switching characteristics over recommended operating free-air temperature range,
$\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54AHC374 |  | SN74AHC374 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| $f_{\text {max }}$ |  |  | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 80* | 130* |  | 70* |  | 70 |  | MHz |
|  |  |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 55 | 85 |  | 50 |  | 50 |  |  |
| tPLH | CLK | Q | $C_{L}=15 \mathrm{pF}$ |  | 8.1* | 12.7* | 1* | 15* | 1 | 15 | ns |
| tPHL |  |  |  |  | 8.1* | 12.7* | 1* | 15* | 1 | 15 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Q | $C_{L}=15 \mathrm{pF}$ |  | 7.1* | 11* | $1^{*}$ | $13^{*}$ | 1 | 13 | ns |
| tpZL |  |  |  |  | 7.1* | 11* | 1* | 13* | 1 | 13 |  |
| tPHZ | $\overline{\mathrm{OE}}$ | Q | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 7.5* | 10.5* | 1* | 12.5* | 1 | 12.5 | ns |
| tplZ |  |  |  |  | 7.5* | 10.5* | 1* | 12.5* | 1 | 12.5 |  |
| tPLH | CLK | Q | $C_{L}=50 \mathrm{pF}$ |  | 10.6 | 16.2 | 1 | 18.5 | 1 | 18.5 | ns |
| tPHL |  |  |  |  | 10.6 | 16.2 | 1 | 18.5 | 1 | 18.5 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Q | $C_{L}=50 \mathrm{pF}$ |  | 9.6 | 14.5 | 1 | 16.5 | 1 | 16.5 | ns |
| tpZL |  |  |  |  | 9.6 | 14.5 | 1 | 16.5 | 1 | 16.5 |  |
| tPHZ | $\overline{\mathrm{OE}}$ | Q | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  | 10.2 | 14 | 1 | 16 | 1 | 16 | ns |
| tplZ |  |  |  |  | 10.2 | 14 | 1 | 16 | 1 | 16 |  |
| $\mathrm{t}_{\text {sk }}(0)$ |  |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  |  | 1.5** |  |  |  | 1.5 | ns |

* On products compliant to MIL-PRF-38535, this parameter is not production tested.
** On products compliant to MIL-PRF-38535, this parameter does not apply.
switching characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 0.5 \mathrm{~V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM(INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54AHC374 |  | SN74AHC374 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| $f_{\text {max }}$ |  |  | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 130* | 185* |  | 110* |  | 110 |  | MHz |
|  |  |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 85 | 120 |  | 75 |  | 75 |  |  |
| tPLH | CLK | Q | $C \mathrm{~L}=15 \mathrm{pF}$ |  | 5.4* | 8.1* | $1^{*}$ | 9.5* | 1 | 9.5 | ns |
| tPHL |  |  |  |  | 5.4* | 8.1* | $1^{*}$ | 9.5* | 1 | 9.5 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Q | $C_{L}=15 \mathrm{pF}$ |  | 5.1* | 7.6* | 1* | $9^{*}$ | 1 | 9 | ns |
| tPZL |  |  |  |  | 5.1* | 7.6* | $1^{*}$ | 9* | 1 | 9 |  |
| tPHZ | $\overline{\mathrm{OE}}$ | Q | $C_{L}=15 \mathrm{pF}$ |  | 4.6* | 6.8* | 1* | 8* | 1 | 8 | ns |
| tPLZ |  |  |  |  | 4.6* | 6.8* | $1^{*}$ | 8* | 1 | 8 |  |
| tPLH | CLK | Q | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  | 6.9 | 10.1 | 1 | 11.5 | 1 | 11.5 | ns |
| tpHL |  |  |  |  | 6.9 | 10.1 | 1 | 11.5 | 1 | 11.5 |  |
| tPZH | $\overline{\mathrm{OE}}$ | Q | $C_{L}=50 \mathrm{pF}$ |  | 6.6 | 9.6 | 1 | 11 | 1 | 11 | ns |
| tPZL |  |  |  |  | 6.6 | 9.6 | 1 | 11 | 1 | 11 |  |
| tPHZ | $\overline{O E}$ | Q | $C_{L}=50 \mathrm{pF}$ |  | 6.1 | 8.8 | 1 | 10 | 1 | 10 | ns |
| tpLZ |  |  |  |  | 6.1 | 8.8 | 1 | 10 | 1 | 10 |  |
| $\mathrm{t}_{\text {sk }}(0)$ |  |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  |  | 1** |  |  |  | 1 | ns |

[^1]noise characteristics, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (see Note 4)

| PARAMETER | SN74AHC374 |  | UNIT |
| :---: | ---: | :---: | :---: |
|  |  | MIN |  |
| MAX |  |  |  |
| $\mathrm{V}_{\mathrm{OL}(\mathrm{P})}$ | Quiet output, maximum dynamic $\mathrm{V}_{\mathrm{OL}}$ | 0.5 | 1 |
| $\mathrm{~V}_{\mathrm{OL}(\mathrm{V})}$ | Quiet output, minimum dynamic $\mathrm{V}_{\mathrm{OL}}$ | -0.5 | -0.8 |
| $\mathrm{~V}_{\mathrm{OH}(\mathrm{V})}$ | Quiet output, minimum dynamic $\mathrm{V}_{\mathrm{OH}}$ | 4 | V |
| $\mathrm{~V}_{\mathrm{IH}(\mathrm{D})}$ | High-level dynamic input voltage | 3.5 | V |
| $\mathrm{~V}_{\mathrm{IL}(\mathrm{D})}$ | Low-level dynamic input voltage |  | V |

NOTE 4: Characteristics are for surface-mount packages only.
operating characteristics, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{pd}} \quad$ Power dissipation capacitance | No load, $\mathrm{f}=1 \mathrm{MHz}$ | 32 | pF |

## PARAMETER MEASUREMENT INFORMATION




VOLTAGE WAVEFORMS PULSE DURATION




[^2]NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 3 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 3 \mathrm{~ns}$.
D. The outputs are measured one at a time with one input transition per measurement.
E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms
www.ti.com
30-Mar-2005

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5962-9686401Q2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-9686401QRA | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-9686401QSA | ACTIVE | CFP | W | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN74AHC374DBLE | OBSOLETE | SSOP | DB | 20 |  | TBD | Call TI | Call TI |
| SN74AHC374DBR | ACTIVE | SSOP | DB | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR Level-1-235C-UNLIM |
| SN74AHC374DGVR | ACTIVE | TVSOP | DGV | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SN74AHC374DW | ACTIVE | SOIC | DW | 20 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR Level-1-235C-UNLIM |
| SN74AHC374DWR | ACTIVE | SOIC | DW | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR Level-1-235C-UNLIM |
| SN74AHC374N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74AHC374NSR | ACTIVE | SO | NS | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR Level-1-235C-UNLIM |
| SN74AHC374PW | ACTIVE | TSSOP | PW | 20 | 70 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SN74AHC374PWLE | OBSOLETE | TSSOP | PW | 20 |  | TBD | Call TI | Call TI |
| SN74AHC374PWR | ACTIVE | TSSOP | PW | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| SNJ54AHC374FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54AHC374J | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54AHC374W | ACTIVE | CFP | W | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Green (RoHS \& no $\mathbf{S b} / \mathrm{Br}$ ): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## PACKAGE OPTION ADDENDUM

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

J ( $\mathrm{R}-\mathrm{GDIP}-\mathrm{T} * *$ )
CERAMIC DUAL IN-LINE PACKAGE
14 LEADS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)
CERAMIC DUAL FLATPACK


4040180-4/D 07/03
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length ( $\operatorname{Dim} A$ ).
(D) The 20 pin end lead shoulder width is a vendor option, either half or full width.

DGV (R-PDSO-G**)


| PIM ** | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{3 8}$ | $\mathbf{4 8}$ | $\mathbf{5 6}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,70 | 3,70 | 5,10 | 5,10 | 7,90 | 9,80 | 11,40 |
| A MIN | 3,50 | 3,50 | 4,90 | 4,90 | 7,70 | 9,60 | 11,20 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
D. Falls within JEDEC: 24/48 Pins - MO-153

14/16/20/56 Pins - MO-194

DW (R-PDSO-G20)
PLASTIC SMALL-OUTLINE PACKAGE


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-013 variation AC.

## MECHANICAL DATA

NS (R-PDSO-G**)
PLASTIC SMALL-OUTLINE PACKAGE
14-PINS SHOWN


| DIM PINS ** | 14 | 16 | 20 | 24 |
| :---: | :---: | :---: | :---: | :---: |
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 .

DB (R-PDSO-G**)
28 PINS SHOWN


| DIM PINS ** | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ | $\mathbf{3 0}$ | $\mathbf{3 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 6,50 | 6,50 | 7,50 | 8,50 | 10,50 | 10,50 | 12,90 |
| A MIN | 5,90 | 5,90 | 6,90 | 7,90 | 9,90 | 9,90 | 12,30 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-150


| PIM PINS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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[^1]:    * On products compliant to MIL-PRF-38535, this parameter is not production tested.
    ** On products compliant to MIL-PRF-38535, this parameter does not apply.

[^2]:    VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

